## **AMENDMENTS TO THE CLAIMS**

- 1-12. (Canceled)
- 13. (Currently Amended) A method of cleaning a substrate of a liquid crystal display panel comprising:

moving the substrate continuously in a linear direction;

jetting deionized water that carries ultrasonic waves onto a side surface of the substrate; brushing the side surface of the substrate with a brush that extends partially along the side surface of the substrate in substantially a straight line; and

cleaning upper and lower surfaces of the substrate.

- 14. (Previously Presented) The method of claim 13, wherein the brush is rotatable.
- 15. (Canceled)
- 16. (Previously Presented) The method of claim 13, wherein cleaning the upper and lower surfaces of the substrate comprises:

rotating cleaning brushes on the upper and lower surface of substrate.

- 17. (Canceled)
- 18. (Previously Presented) The method of claim 16, wherein the cleaning brushes are arranged at the upper and lower surfaces of the substrate, respectively.
  - 19-22. (Canceled)
- 23. (Currently Amended) A method of cleaning a substrate of a liquid crystal display panel comprising:

removing foreign substances on a side surface of the substrate by jetting deionized water that carries ultrasonic waves onto the side surface of the substrate with a water jet device and brushing the side surface of the substrate with cleaning brushes that extend partially along the side surface of the substrate <u>in substantially a straight line</u> while moving the substrate continuously in a linear direction; and

removing foreign substances on the upper and lower surfaces of the substrate by brushing the upper and lowers surface of the substrate with brushes.

- 24. (Original) The method of claim 22, wherein the water jet device causes vibration on the side surface of the substrate.
- 25. (Original) The method of claim 23, wherein the vibration is generated by ultrasonic waves.

## 26-27. (Canceled)

28. (Currently Amended) A method of cleaning a substrate having an upper surface and a lower surface separated by at least two opposing side surfaces, the method comprising: moving the substrate continuously in a linear direction;

brushing at least two opposing side surfaces with cleaning brushes that extend partially along the at least two opposing side surfaces of the substrate in substantially a straight line; cleaning at least one of the upper and lower surfaces; and spraying water that carries ultrasonic waves onto the at least two brushed side surfaces.

- 29. (Previously Presented) The method of claim 28, further including brushing at least two opposing side surfaces before brushing at least one of the upper and lower surfaces.
- 30. (Previously Presented) The method of claim 28, wherein the water includes deionized water.
  - 31. (Canceled)
- 32. (Previously Presented) The method of claim 28, wherein cleaning at least one of the upper and lower surfaces includes brushing the at least one of the upper and lower surfaces.